

Vishay High Power Products

FlipKY®, 1 A



FlipKY[®]

PRODUCT SUMMARY I_{F(AV)} 1 A V_R 40 V

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FEATURES

- Ultralow V_F to foot print area
- · Low leakage
- · Low thermal resistance
- · One-fifth footprint of SMA
- Super low profile (< 0.7 mm)
- · Available tested on tape and reel
- Small foot print, surface mountable
- · Low forward voltage drop
- · High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- · Designed and qualified for consumer level

DESCRIPTION

True chip-scale packaging is available from Vishay HPP. The FCSP1H40ETR surface mount Schottky rectifier has been designed for applications requiring low forward drop and very small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

The FlipKY® package, is one-fifth the footprint of a comparable SMA package and has a profile of less than 0.7 mm. Combined with the low thermal resistance of the die level device, this makes the FlipKY the best device for applications where printed circuit board space is at a premium and in extremely thin application environments such as battery packs, cell phones and PCMCIA cards.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	VALUES	UNITS		
I _{F(AV)}	Rectangular waveform	1.0	A		
V _{RRM}		40	V		
I _{FSM}	t _p = 5 μs sine	250	A		
V _F	1.0 Apk, T _J = 125 °C	0.42	V		
TJ	Range	- 55 to 150	°C		

VOLTAGE RATINGS					
PARAMETER	SYMBOL	FCSP1H40ETR	UNITS		
Maximum DC reverse voltage	V_{R}	40	V		
Maximum working peak reverse voltage	V_{RWM}	40	V		

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ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	I _{F(AV)}	50 % duty cycle at T _{PCB} = 117 °C, rectangular waveform		1.0	
Maximum peak one cycle non-repetitive surge current at 25 °C	l=	5 μs sine or 3 μs rect. pulse Following any rated load condition and with rated V _{RRM} applied	250	Α	
	IFSM		21		
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 2.0 \text{A}, L = 5.0 \text{mH}$		10	mJ
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		2.0	Α

ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
Maximum forward voltage drop See fig. 1	V (1)	1 A	T _J = 25 °C	0.48	0.52	V
		2 A		0.53	0.57	
	V _{FM} ⁽¹⁾	1 A	T _{.1} = 125 °C	0.36	0.42	
		2 A	- IJ = 125 C	0.43	0.50	
Maximum reverse leakage current See fig. 2		V _R = Rated V _R		4	10	μA mA
		V _R = 20 V	T _{.1} = 25 °C	0.5	1	
		V _R = 10 V		0.2	0.5	
	I _{RM} ⁽¹⁾	V _R = 5 V		0.15 2.5	0.3	
	IRM \"	V _R = Rated V _R			4	
		V _R = 20 V	T _{.1} = 125 °C	0.9	2	
		V _R = 10 V	TJ = 125 C	0.6	1.5	
		V _R = 5 V		0.5	1	
Maximum junction capacitance	C _T	V _R = 5 V _{DC} (test signal range 100 kHz to 1 MHz) 25 °C		=	160	pF
Maximum voltage rate of change	dV/dt	Rated V _R		-	10 000	V/µs

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 $^{^{(1)}\,}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range	$T_{J}^{(1)}, T_{Stg}$		- 55 to 150	°C	
Typical thermal resistance, junction to PCB	R _{thJL} (2)	DC operation	40	°C/W	
Maximum thermal resistance, junction to ambient	R _{thJA}		62	C/VV	

Notes

- $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$ thermal runaway condition for a diode on its own heatsink
- (2) Mounted on 1" square PCB



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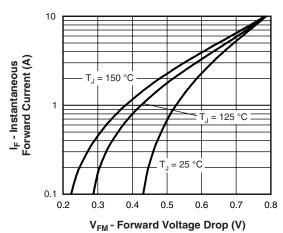
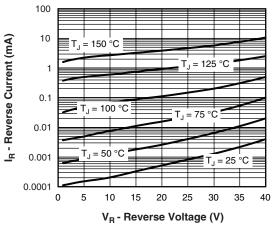


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)



www.DataSheet4U.com Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

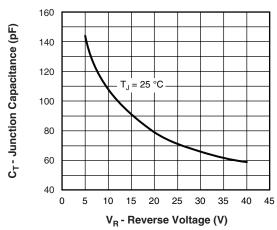


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

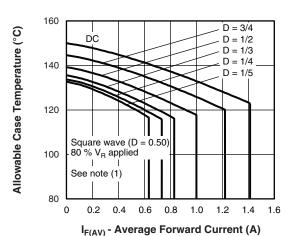


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

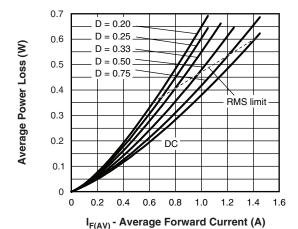


Fig. 5 - Forward Power Loss Characteristics (Per Leg)

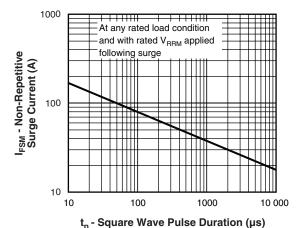


Fig. 6 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{th,JC}$; $Pd = Forward power loss = I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = Inverse$ power loss = $V_{R1} \times I_{R}$ (1 - D); I_{R} at 80 % V_{R} applied

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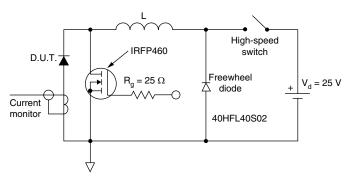


Fig. 7 - Unclamped Inductive Test Circuit

LINKS TO RELATED DOCUMENTS				
Dimensions	http://www.vishay.com/doc?95359			
Part marking information	http://www.vishay.com/doc?95281			
Packaging information	http://www.vishay.com/doc?95062			
SPICE model	http://www.vishay.com/doc?95292			

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